

Mass Spectrometry



300mm Resist-Torr® XD HIGH SENSITIVITY PHOTORESIST DETECTION RGA

The 300mm Resist-Torr[®] XD incorporates V-lens[™] technology advancing the proven performance of the 300mm Resist-Torr system to a new level of sensitivity, selectivity, and confidence in degas applications compared with conventional quadrupole mass spectrometry-based residual gas analyzers.

The patented V-lens design provides significantly improved detection power for the most challenging wafer degas applications where low ppb detection of contaminants and photoresist is required (<15ppb specified with Argon or Nitrogen).

With V-lens technology, the 300mm Resist-Torr XD overcomes the issues presented by challenging gases such as Argon that the limited detection power of conventional systems cannot address. In combination with the unique PR index from MKS, this powerful platform delivers a clear advantage for the monitoring and detection of trace gases. Process engineers are able to identify potentially costly wafer contamination earlier and maximize process yield.

The 300mm Resist-Torr XD consists of an optimum combination of V-lens technology, a closed ion source quadrupole mass analyzer and a fast response capillary inlet, together with advanced proprietary algorithms developed exclusively for the degas chambers on industry leading 300mm PVD cluster tools.

Features & Benefits

- V-lens technology provides:
 - Lower detection limits up to 10 times improvement at lower masses (<15ppb)
 - Higher data quality more reliable distinction between gases and background
 - Cleaner baseline lower noise across the mass scale
 - 2x improvement in absolute sensitivity from improved focusing
- Fully automated process monitoring means no operator necessary

 Detection of photoresist contamination during high pressure (~8 Torr) degas before wafers enter into 300mm PVD chambers

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- Calculation of the PR Index[®] a measure of photoresist contamination level in the degas chamber
- Variable alarm sensitivity to match product conditions in your fab or process tool
- Powerful optional data review feature to maximize ROI

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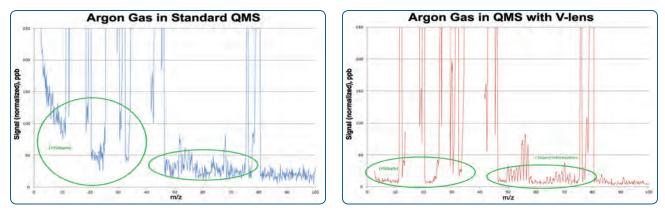


Figure 1 -

Reduced baseline and improved sensitivity with V-lens technology - data acquired from purified Argon at atmospheric pressure, with and without V-lens technology.

V-lens[™] Technology

Degas processes typically employ inert gases such as Argon or Nitrogen. The use of these gases can be challenging as they generate an elevated baseline in RGAs due to large amounts of chemical background noise caused by metastable decay. This results in reduced sensitivity which can be problematic for manufacturers who want to identify changes in trace gases (which are indicative of issues during the manufacturing process) quickly and easily.

V-lens technology, a unique enabling solution, helps to overcome this issue by providing a consistently low massindependent baseline (Figure 1) and detection levels in the low ppb range. This is achieved with unique ion optics that utilize a patented double-focusing and deflection mechanism that significantly reduces background and enhances sensitivity (Figure 2).

The result is a gas analyzer with limits of detection in the low ppb range without compromise to any other aspect of instrument performance.

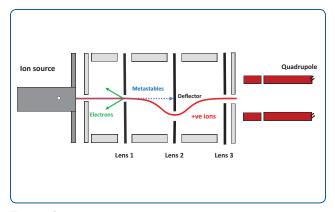


Figure 2 —

V-lens lon Optics Technology - Trajectories of negative ions (green), positive ions (red), neutral ions (blue) in the V-lens ion optics, reducing metastable decay.

Figure 3 shows a real life example where degas monitoring of a signature mass could only be achieved when utilizing V-lens technology. The baseline is significantly reduced allowing for unequivocal identification of the target mass. This allows for faster and easier identification of trace gases which is critical in many manufacturing processes.

PR Index® and Fab Integration

When the system is utilized with the powerful features of the Process Eye[™] and TOOLweb[®] RGA sensor control software package, the result is completely automated operation and highly reliable and sensitive photoresist detection. Unscheduled downtimes are reduced and device yields are improved.

The 300mm Resist-Torr XD considers many different parameters of the degas step and combines that data to provide information in the form of a meaningful number, without the need for user-interpretation. This measurement, termed the PR Index[®], is a normalized measure of wafer borne photoresist contamination that can be presented in various forms to compare data over time.

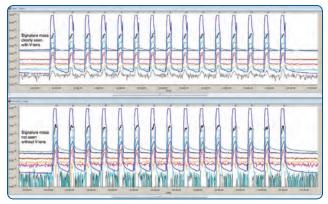


Figure 3 -

V-lens technology – providing reduced baseline and increased sensitivity for the monitoring of a signature mass.

300mm Resist-Torr XD

The 300mm Resist-Torr XD can interrupt the processing of any wafer automatically, without operator intervention, if a wafer enters the vacuum system with detrimental levels of residual photoresist, as determined by the PR Index. The example (Figure 4) shows a PR index trace for a series of test wafers and provides the user a selective way to detect patterns that indicate contamination. The PR index is shown as a black trend in the top line and the alarm level as a yellow line. The black PR line can be seen to elevate indicating that it has identified contaminated wafers. The PR Index allows a more sensitive and reliable method for detecting photoresist contamination.

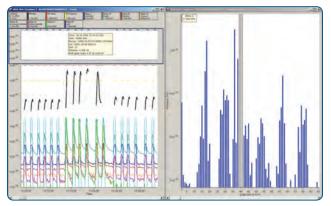


Figure 4 -

PR Index for characterization of wafer contamination

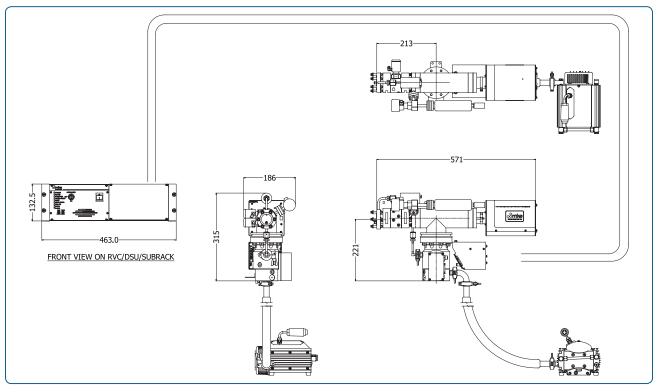
TOOLweb® RGA

Using TOOLweb RGA sensor integration option for process tools, the 300mm Resist-Torr XD can be used as a degas chamber sensor in a completely automated process environment (Figure 5). TOOLweb RGA maintains a constant monitor of tool activities with all sensor data being framed by wafer logistics before alarm models are applied. Full alarm and data reporting to the FAB host and FDC are available so real time monitoring of chamber conditions and flagging of any process excursions from ideal conditions is possible.

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Figure 5 -

TOOLweb RGA home page screen for a tool with 300mm Resist-Torr degas modules





Specifications and Ordering Information

Performance	
Mass Range	1-200 amu
Detector System	Dual (Faraday and Secondary Electron Multiplier)
Minimum Detectable Concentration	<15ppb (specified with Argon or Nitrogen)
Mass Stability	Better than ±0.1 amu over 8 hours at stable ambient temperature
Resolution	Better than 10% valley between peaks of equal height throughout the mass range
Analyzer & Housing	
Ion Source	High sensitivity, closed ion source
Filaments	Replaceable twin Thoria filaments
Analyzer Housing Base Pressure	Better than 5x10 ⁻⁹ Torr after bakeout
Inlet	Dual path with fast-response capillary for degas monitoring and high
	conductance for base vacuum. Includes heater jacket.
Mass Filter	Double filter (1" "RF only" pre-filter with 4" main filter)
Mounting Flange	2.75" Conflat [®] flange, SS capillary
Bakeout Temperature & Bakeout Jacket	Included for 180°C bakeout
Vacuum Hardware	60 l/s turbomolecular pump with high conductance analyzer housing,
	fast response capillary inlet system, automated vacuum controller (RVC)
	completely interlocked and integrated
Foreline Pump	Dry diaphragm standard
Calibration Hardware	Reference gas standard for automated calibration
Control Unit/PC	
Control Module Weight	1.7 kg
Power	88-264 VAC, 47/63 Hz, 600 Watts
Maximum Operating Conditions	Electronics: 10-40°C, 80% RH (non-condensing)
LED Status Indication	Interlock status, filament emission, SEM, power and communications
I/O Capability	4 analog inputs and 2 outputs (plus 1 dedicated gauge input).
	Optional support for a large number of both analog and digital inputs and
	outputs, including relay control
Other Facilities	Leak check headset socket, external filament trip socket, instrument reset
Software	Process Eye Professional fully network compatible control platform generating
	32bit or 64bit Microsoft [®] Windows [®] XP, Vista, Server 2008 or Windows 7*
	(*recommended)
Communications	Ethernet CAT-5e
Minimum PC Specification Required	Intel [®] Pentium IV [®] or AMD Athlon XP 1.2GHz, 1GB RAM, 120 GB hard drive,
	dependent upon total number of sensors on the computer and the operating
	system in use. Multi-sensor installation may require higher specifications.
	Simultaneous Multi-Sensor Process Eye Professional client/server configuration
	offers flexible multi-sensor operation.
RGA Controller to Vacuum System Cables	Length 33' (10 m) standard RGA. Other lengths available dependent upon
	process system and customer requirements
Compliance	CE
Facilities	
Power	88-264 VAC, 47/63 Hz, 600 Watts
Pneumatics	60-80 psig CDA

Please contact your local MKS office for price and availability information.



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